

NXP BSP LPC8N04 Release Notes

BSP LPC8N04 version release history and known issues

The version history and known issue lists on this page are for v1.xx releases of BSP only.

Some issues are known at the time of the versioned package release.



BSP v1.2 release (Released: 01/28/2019): NXP LPC8N04 Development Board support

Features Added

- 1) Added peripheral examples

Changes and Fixes

- 1) RTC Keil Release : change debugger from "ULINK" to "CMSIS-DAP"
- 2) Energy Harvest : change output binary name from "pmu" to "energy_harvest"

Known Issues

None

BSP v1.10 release (Released: 01/15/2018): NXP LPC8N04 Development Board support

Features Added

- None

Changes and Fixes

- Cleaned up driver files

Known issues

- None

BSP v1.00 release (Released: 12/05/2017): NXP LPC8N04 Development Board support

Features Added

- None

Changes and Fixes

- None

Known issues

- None

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